

SPECIFICATION FOR APPROVAL

Customer :		
Customer Part No:		
SHINING Part No:	PLCC2 1608 Mono Color	r
Emitted color:	SN-NE1608BAAAG-N	Green
	SN-NE1608BAAAY-N	Yellow
	SN-NE1608BAAAO-N	Orange
	SN-NE1608BAAAR-N	Red
	SN-NE1608BAABR-N	Red

Revision History			
Date	Revision History	Prepared	
2022.12.12	New Version	A/0	

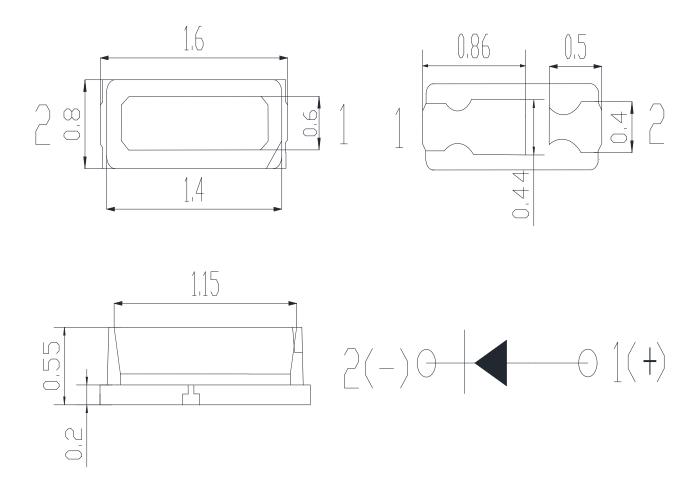
Confirmed By Customer	Approval by	Prepared by
	Liusan	Shaochengcheng



Feature

- △ Viewing angle:120 deg
- Δ 1.6mm×0.8mm×0.55mm
- Δ Pb-free
- Δ RoHS compliant lead-free soldering compatible
- Δ AEC-Q102 Qualified
- Δ Precondition: Bases on JEDEC J-STD 020D Level 2a

Package Outline Package Outline





- All dimensions are in millimeters;
 Tolerances are ±0.2mm unless otherwise noted.

ATTENTION OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** SENSITIVE DEVICES



Product Code

SN	_	NE	1608	В	A	A	A	R	_	N
Company: Shining		Automotive	Product Size	Lead frame	Number of Chips A:One	Drive Current:20 mA	Process Code	Red		NO Zener

Parameter	Symbol	Value	Unit
Forwardcurrent	lf	25	mA
Reversevoltage	Vr	5	V
Operating temperature range	Тор	-40~+110	${\mathbb C}$
Storage temperature range	Tstg	-40~+110	${\mathbb C}$
Pulse Forward Current (Pulse Width ≦ 100 μs and Duty ≦ 3%)	lfp	35	mA
Electrostatic Discharge	ESD	2000	V

Electro-optical characteristics at Ta=25 °C (IF@20mA)

Model	Part Number		inant igth(nm)	Luminous intensity (mcd)		Forward v	oltage(v)
		Min.	Max.	Min.	Max.	Min.	Max.
Green	SN-NE1608BAAAG-N	520	530	900	1800	3.0	3.6
Yellow	SN-NE1608BAAAY-N	587	593	450	1125	1.8	2.4
Orange	SN-NE1608BAAAO-N	600	612	450	1125	1.8	2.4
Red	SN-NE1608BAABR-N	617	627	450	1125	1.8	2.4
Red	SN-NE1608BAAAR-N	627	637	355	715	1.8	2.4



Electrical Characteristics at Ta=25℃

Parameter	Test Condition	Symbol		Value		Unit
i didilictei	rest containion	Oymbor	Min.	Тур.	Max.	
Viewing angle at 50% lv	If=20mA	2 θ 1/2	<u></u>	120	<u></u>	Deg
Reverse current	Vr=5V	lr	<u></u>		10	μΑ

NOTE: (Tolerance: IV±10%, Vf ±0.1V, WD ±1nm)

Forward voltage range

Forward Voltage Unit: V@20mA					
Bin Code	MIN	MAX			
F00	1.8	2.0			
F01	2.0	2.2			
F02	2.2	2.4			
F03	2.4	2.6			
F04	2.6	2.8			
F05	2.8	3.0			
F06	3.0	3.2			
F07	3.2	3.4			
F08	3.4	3.6			



Luminous intensity range

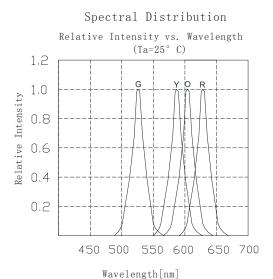
I	Luminous Intensity Unit: mcd@20mA				
Bin Code	MIN	MAX			
T1	285	355			
T2	355	450			
U1	450	560			
U2	560	715			
V1	715	900			
V2	900	1125			
W1	1125	1400			
W2	1400	1800			

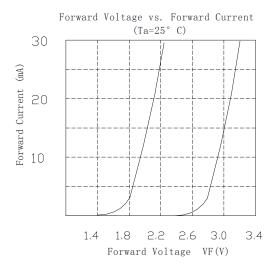
Chromaticity range

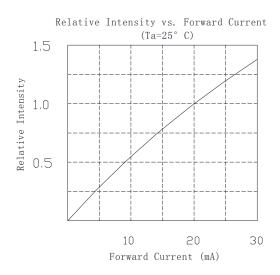
	Dominant Wave	elength Unit: nm@20mA	
Colour	Bin Code	MIN	MAX
AG	G1	520	525
AG	G2	525	530
AY	YB	587	590
Ai	YC	590	593
	AO	600	603
AO	ВО	603	606
AO	СО	606	609
	DO	609	612
	R2	617	620
BR	R3	620	623
	R4	623	627
	RA	627	630
AR	RB	630	634
	RC	634	637

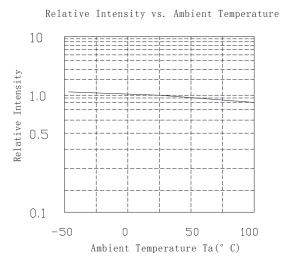


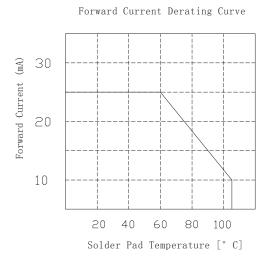
Typical optical characteristics curves











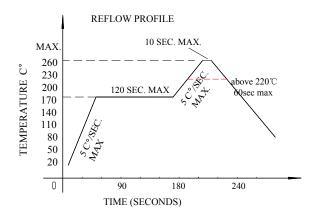


Reflow profile

- Soldering condition
 - Recommended soldering conditions

Reflow Soldering		Hand S	oldering
Pre-heat	160∼180℃	Temperature	300℃ Max.
Pre-heat time	120 seconds Max.		
Peak temperature	260°C Max.	Soldering time	3 second Max.
Soldering time	10 seconds Max.		(one time only)
Condition	Refer to Temperature-profile		

- After reflow soldering rapid cooling should be avoided
- Temperature-profile (Surface of circuit board)
 Use the following conditions shown in the figure.



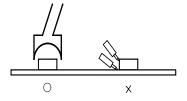
- 1. Reflow soldering should not be done more than two times
- 2. When soldering ,do not put stress on the LEDs during heating

■ Soldering iron

- 1. When hand soldering, keep the temperature of the iron under 300° C, and at that temperature keep the time under 3 sec.
- 2. The hand soldering should be done only a time
- 3. The basic spec is \leq 5 sec. when the temperature of 260 $^{\circ}$ C, do not contact the resin when hand soldering

■ Rework

- 1. Customer must finish rework within 5 sec und
- 2. The head of iron can not touch the resin
- 3. Twin-head type is preferred.



CAUTIONS

The encapsulated material of the LEDs is silicone. Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when using the picking up nozzle, the pressure on the silicone resin should be proper.



Reliability

(1)TEST ITEMS AND RESULTS

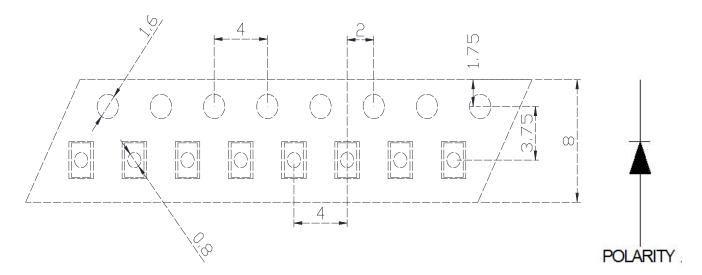
Test Item	Test Conditions	Note	Number of Damaged
Resistance to Soldering Heat(Reflow Soldering)	Tsld=260°C,10sec	3 times	0/22
Thermal Shock	-40 °C 30min ↑↓<5min 105 °C 30min	1000 cycle	0/22
High Temperature Storage	T _a =110℃	1000 hrs	0/22
Humidity Heat Storage	T _a =85°C RH=85%	1000 hrs	0/22
Low Temperature Storage	T _a =-40°C	1000 hrs	0/22
High Temperature Life Test	Ta=110℃ IF=10mA	1000 hrs	0/22
Low Temperature Life Test	T _a =-40 °C IF=25mA	1000 hrs	0/22
Temperature Cycle	-40°C 10min ↑↓15min 105°C 10min I _F =10mA 5Min On,5Min Off	1000 cycle	0/22
High Humidity Heat Life Test	Ta=60°C RH=85% IF=25mA	1000 hrs	0/22
Pulse Life Test	T_a =55 $^{\circ}$ C Pulse Forward Current 35mA Pulse Width \leq 100 μ s and Duty \leq 3%	1000 hrs	0/22

(2) CRITERIA FOR JUDGING THE DAMAGE

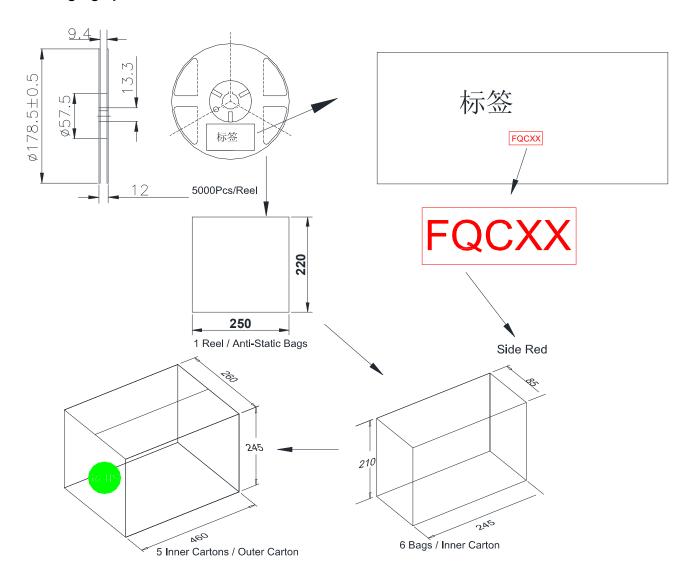
ltem	Symbol	Criteria for Judgement	
		Min.	Max.
Forward Voltage	VF	_	Initial Data×1.1
Luminous Intensity	IV	Initial Data×0.8	_
Wavelength	NM	Initia-2	Initia+2



Packaging Specifications



Packaging specifications





CAUTIONS

Storage conditions

Before opening the package:

The LEDs should be kept at 30° C or less and 70%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material (silica gel) is recommended. After opening the package:

The LEDs should be kept at 30° C or less and 50%RH or less. The LEDs should be soldered within 24 hours (1days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It is also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.

This specification shining has the right of final interpretation